DESCRIPTION

The A6303A is designed for portable RF and wireless applications with demanding performance and space requirements. The A6303A performance is optimized for battery-powered systems to deliver ultra low noise and low quiescent current. Regulator ground current increases only slightly in dropout, further prolonging the battery life. The A6303A also works with low-ESR ceramic capacitors, reducing the amount of board space necessary for power applications, critical in hand-held wireless devices. The A6303A consumes less than 0.01µA in shutdown mode and has fast turn-on time less than 50µs. The other features include ultra low dropout voltage, high output accuracy, current limiting protection, and high ripple rejection ratio.

The A6303A is available in SOT-23, SOT-25 and SC70-5 Packages.

ORDERING INFORMATION

Package Type	Part Number		
SOT-23	E3	A6303AE3R-XXZ	
SPQ: 3,000pcs/Reel	ES	A6303AE3VR-XXZ	
SOT-25	E5	A6303AE5R-XXZ	
SPQ: 3,000pcs/Reel	=3	A6303AE5VR-XXZ	
SC70-5	C5	A6303AC5R-XX	
SPQ: 3,000pcs/Reel	CS	A6303AC5VR-XX	
Note	XX: Output Voltage 12= 1.2V, 15= 1.5V, 18= 1.8V, 25= 2.5V, 28= 2.8V, 30= 3.0V, 33= 3.3V, 50= 5.0V Z: Output Type A = A Type V: Halogen free Package R: Tape & Reel		
AiT provides all RoHS products			

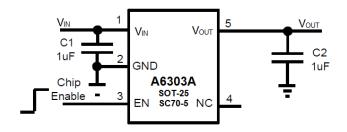
FEATURES

- Ultra-low Noise for RF Application
- Ultra-Fast Response in Line/Load Transient
- <0.01µA Standby Current When Shutdown (SOT-25, SC70-5)
- Low Dropout: 210mV@300mA
- Wide Operating Voltage Ranges: 2V to 6V
- Wide Output Voltage Range: 1.2V to 5V
- TTL-logic-Controlled Shutdown Input (SOT-25, SC70-5)
- Low Temperature Coefficient
- **Current Limiting Protection**
- Thermal Shutdown Protection
- Only 1µF Output Capacitor Required for Stability
- High Power Supply Rejection Ratio
- Custom Voltage Available
- Fast output discharge
- Available in SOT-23. SOT-25. SC70-5 **Packages**

APPLICATION

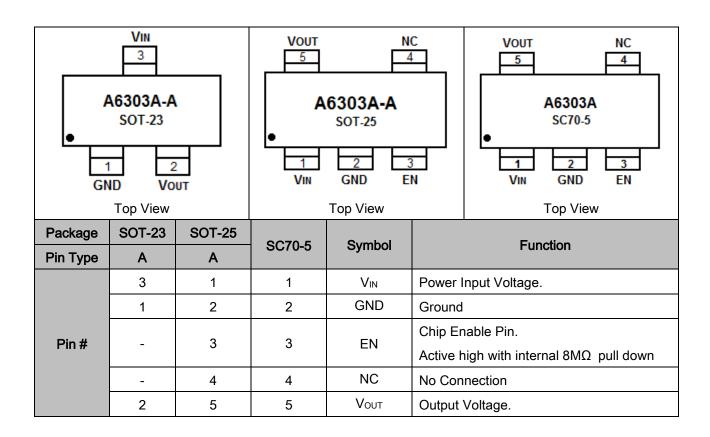
- Cellular and Smart Phones
- Battery-Powered Equipment
- Laptop, Palmtops, Notebook Computers
- Hand-Held Instruments
- **PCMCIA Cards**
- MP3/MP4/MP5 Players
- Portable Information Appliances

TYPICAL APPLICATION



NOTE: Output capacitor (C2 ≥ 2.2uF) is recommended in A6303A-1.2V, A6303A-1.3V, A6303A-1.5V and A6303A-1.8V application to assure the stability of circuit.

PIN DESCRIPTION



THERMAL RESISTANCE

Package	θја	Ө лс
SOT-23	250°C/W	130°C/W
SOT-25	250°C/W	130°C/W
SC70-5	333°C/W	170°C/W

NOTE: Thermal Resistance is specified with approximately 1 square of 1 oz copper.

ABSOLUTE MAXIMUM RATINGSNOTE1

V _{IN} , Input Supply Voltage	
SOT-25, SC70-5	-0.3V ~ +6V
SOT-23	-0.3V ~ +6.5V
EN Pin Input Voltage (SOT-25, SC70-5)	-0.3V ~ V _{IN}
Output Voltages	$-0.3V \sim V_{IN} + 0.3V$
Output Current	300mA
Maximum Junction Temperature	
SOT-25, SC70-5	150°C
SOT-23	125°C
Operating Temperature RangeNOTE2	-40°C ~ 85°C
Storage Temperature Range	-65°C ~ 125°C
Lead Temperature (Soldering, 10s)	300°C

Stresses above may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated in the Electrical Characteristics are not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

NOTE1: Absolute Maximum Ratings are those values beyond which the life of a device may be impaired.

NOTE2: The A6303A is guaranteed to meet performance specifications from 0°C to 70°C. Specifications over the -40°C to 85°C operating temperature range are assured by design, characterization and correlation with statistical process controls.

ELECTRICAL CHARACTERISTICS NOTES

V_{IN} = 3.6V, EN = V_{IN} (SOT-25, SC70-5), C_{IN} = C_{OUT} = 1uF, T_A = 25°C, unless otherwise specified.

Paramete	er	Symbol	Conditions		Min	Тур	Max	Unit
Input Voltage		V _{IN}			2	-	6	V
Output Voltage Accu	racy ^{NOTE4}	ΔVουτ	V _{IN} = 3.6V, I _{OUT} = 1mA		-2	-	+2	%
Current Limit		Ішм	R _{LOAD} = 1Ω		400	430	-	mA
		lα	V _{EN} > 1.2V,	SOT-25				
			I _{OUT} = 0mA	SC70-5	-	90	130	μΑ
Quiescent Current			I _{OUT} = 0mA	SOT-23				
D (1)/ II		I _{OUT} = 200mA, V _{OUT} = 2.8V		_{UT} = 2.8V	-	130	180	.,
Dropout Voltage		V _{DROP}	I _{OUT} = 300mA, V _O	_{UT} = 2.8V	-	210	300	mV
Line RegulationNOTES	Line Regulation ^{NOTE5}		V _{IN} = 3.6V to 5.5V I _{OUT} = 1mA		-	0.05	0.17	%/V
Load RegulationNOTE	6	ΔV_{LOAD}	1mA < I _{OUT} < 300	mA	-	-	2	%/A
Output Voltage ^{NOTE7} Temperature Coeffic	-		I _{OUT} = 1mA		1	±60	ı	ppm/°C
Standby Current		I _{STBY}	V _{EN} = GND, Shutdown	SOT-25 SC70-5	-	0.01	0.1	μΑ
EN Input Bias Curre	nt	I _{IBSD}	V _{EN} =GND or V _{IN}	V_{EN} =GND or V_{IN} SOT-25 SC70-5		-	500	nA
EN Input	Logic Low	V _{IL}	V_{IN} = 3V to 5.5V, Shutdown	SOT-25 SC70-5	1	-	0.4	
Threshold			$V_{IN} = 3V \text{ to } 5.5V,$	SOT-25	1.2 -		V	
	Logic High	ViH	Start up	SC70-5		-	-	
Output Noise Voltage	t Noise Voltage $e_{NO} = \frac{10 \text{Hz to } 100 \text{kHz}}{I_{OUT} = 200 \text{mA}}$		10Hz to 100kHz,		-	100	-	μV _{RMS}
Power Supply Rejection Ratio	f = 217Hz		I _{OUT} = 100mA		ı	-78		dB
	f = 1kHz	PSRR				-72	-	
	f = 10kHz					-52		
Thermal Shutdown Temperature		T _{SD}	Shutdown, Temp increasing		-	165	-	۰C
Thermal Shutdown F	Thermal Shutdown Hysteresis				-	30	-	۰C

NOTE3: 100% production test at +25°C. Specifications over the temperature range are guaranteed by design and characterization.

NOTE4: Output voltage accuracy: ±2%.

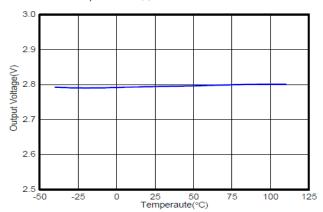
NOTE5: Line regulation is calculated by $\Delta V_{\text{LINE}} = \left[\left(V_{\text{OUT1}} - V_{\text{OUT2}} \right) / \left(\Delta V_{\text{IN}} \, x \, V_{\text{OUT(NORMAL)}} \right] \, x \, 100$. Where V_{OUT1} is the output voltage when V_{IN} = 5.5V, and V_{OUT2} is the output voltage when V_{IN} = 3.6V, ΔV_{IN} = 1.9V, $V_{OUT\,(NORMAL)}$ = 2.8V.

NOTE6: Load regulation is calculated by $\Delta V_{\text{LOAD}} = [(V_{\text{OUT1}} - V_{\text{OUT2}}) / (\Delta I_{\text{OUT}} \times V_{\text{OUT(NORMAL)}})] \times 100$. Where V_{OUT1} is the output voltage when I_{OUT} = 1mA, and V_{OUT2} is the output voltage when I_{OUT} = 300mA. ΔI_{OUT} = 0.299A, $V_{\text{OUT}(\text{NORMAL})}$ = 2.8V.

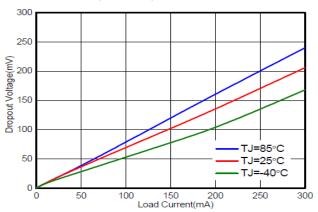
NOTE7: The temperature coefficient is calculated by $TC_{VOUT} = [\Delta V_{OUT} / (\Delta T \times V_{OUT})]$

TYPICAL PERFORMANCE CHARACTERISTICS

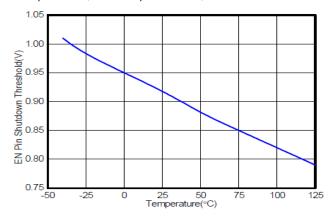
1. Output Voltabe vs. Temperature $V_{IN} = 3.6V$, $C_{IN} = C_{OUT} = 1uF$



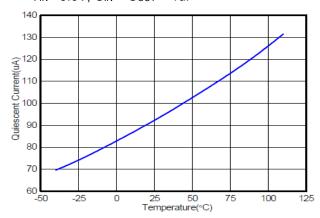
3. Dropout Voltage vs. Load Current Vout = 2.8V(SOT-23,), CIN = COUT = 1uF



5. EN Pin Shutdown Threshold Vs. Temperature $(SOT-25, SC70-5) V_{IN}=3.6V, C_{IN}=C_{OUT}=1uF$

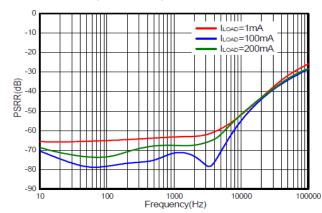


2. Quiescent Current vs. Temperature V_{IN} = 3.6V, C_{IN} = C_{OUT} = 1uF



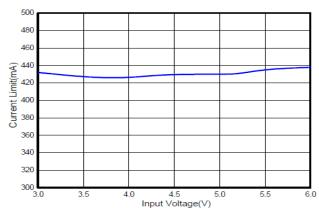
4. PSRR

 $V_{IN} = 4.2V$, $C_{IN} = 1uF$, $C_{OUT} = 1uF$ X7R



6. Current Limit Vs. Input Voltage

 $C_{IN} = C_{OUT} = 1uF, V_{OUT} = 2.8V$



7. Load Transient Response

 V_{IN} =5V, V_{OUT} =2.8V, C_{IN} = C_{OUT} = 1uF, I_{OUT} =1mA to 50mA CH2:lour 50mA/Div DC Coupled CH1:Vout 10mV/Div AC Coupled Ch1 10.0mV \ Ch2 50.0mAΩ \ M 1.00ms A Ch2 J 34.0mA 26 MAY 2009 13:56:55 Δ: 53.0mA @: -54.0mA

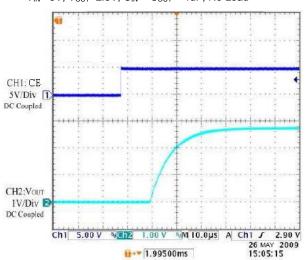
3.64400ms

9. Line Transient Reaponse

 V_{IN} =4V to 5V, V_{OUT} =2.8V, C_{IN} = C_{OUT} = 1uF, I_{OUT} =1mA CH1:VDD 1V/Div DC Coupled CH2:Vout 10mV/Div AC Coupled 1 Ch1 1.00 V % Ch2 10.0mV \ M1.00ms A Ch1 J 4.32 V 26 MAY 2009 14:44:06 # −940.000µs

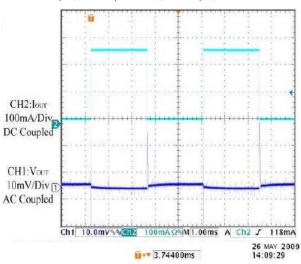
11. Start Up (SOT-25, SC70-5)

 V_{IN} = 5V, V_{OUT} =2.8V, C_{IN} = C_{OUT} = 1uF, No Load



8. Load Transient Response

 V_{IN} =5V, V_{OUT} =2.8V, C_{IN} = C_{OUT} = 1uF, I_{OUT} =1mA to 250mA

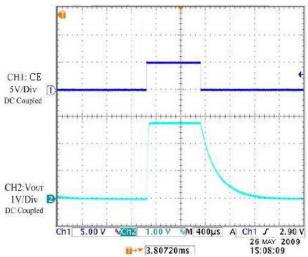


10. Line Transient Response

 V_{IN} =4V to 5V, V_{OUT} =2.8V, C_{IN} = C_{OUT} = 1uF, I_{OUT} =100mA CHI:VDD 1V/Div DC Coupled CH2:Vout 10mV/Div 2 AC Coupled 1.00 V %Ch2 10.0mV M1.00ms A Ch1 J 4.32 V #→▼ -896.000µs

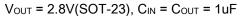
12. EN Pin Shutdown Response (SOT-25, SC70-5)

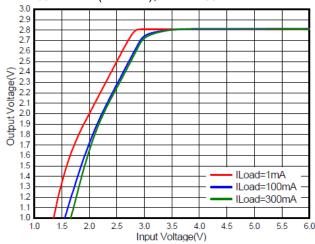
 V_{IN} = 5V, V_{OUT} =2.8V , C_{IN} = C_{OUT} = 1uF, No Load



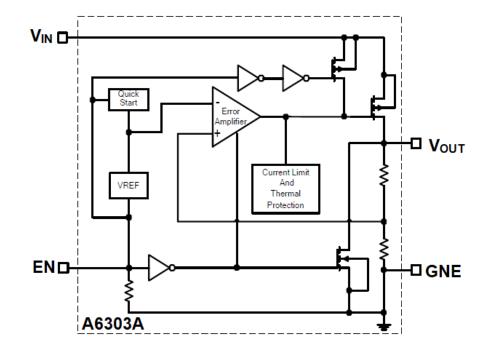


13. Vout vs. Vin





BLOCK DIAGRAM



DETAILED INFORMATION

Like any low-dropout regulator, the external capacitors used with the A6303A must be carefully selected for regulator stability and performance. Using a capacitor whose value is > 1 μ F on the A6303A input and the amount of capacitance can be increased without limit. The input capacitor must be located a distance of not more than 0.5 inch from the input pin of the IC and returned to a clean analog ground. Any good quality ceramic or tantalum can be used for this capacitor. The capacitor with larger value and lower ESR (equivalent series resistance) provides better PSRR and line-transient response. The output capacitor must meet both requirements for minimum amount of capacitance and ESR in all LDOs application. The A6303A is designed specifically to work with low ESR ceramic output capacitor in space-saving and performance consideration. Using a ceramic capacitor whose value is at least 1 μ F with ESR is > 25m Ω on the A6303A output ensures stability. The A6303A still works well with output capacitor of other types due to the wide stable ESR range. Output capacitor of larger capacitance can reduce noise and improve load transient response, stability, and PSRR. The output capacitor should be located not more than 0.5 inch from the VouT pin of the A6303A and returned to a clean analog ground.

Enable Function (SOT-25, SC70-5)

The A6303A features an LDO regulator enable/disable function. To assure the LDO regulator will switch on; the EN turn on control level must be greater than 1.2 volts. The LDO regulator will go into the shut down mode when the voltage on the EN pin falls below 0.4 volts. For to protect the system, the A6303A have a quick discharge function. If the enable function is not needed in a specific application, it may be tied to V_{IN} to keep the LDO regulator in a continuously on state.

Thermal Considerations

Thermal protection limits power dissipation in A6303A. When the operation junction temperature exceeds 165°C, the OTP circuit starts the thermal shutdown function turn the pass element off. The pass element turns on again after the junction temperature cools by 30°C.

For continue operation, do not exceed absolute maximum operation junction temperature 125°C. The power dissipation definition in device is:

$$P_D = (V_{IN} - V_{OUT}) \times I_{OUT} + V_{IN} \times I_Q (SOT-23)$$

The maximum power dissipation depends on the thermal resistance of IC package, PCB layout, the rate of surroundings airflow and temperature difference between junction to ambient. The maximum power dissipation can be calculated by following formula:

$$P_D(MAX) = (T_J(MAX) - T_A)/\theta_{JA}$$



Where $T_{J(MAX)}$ is the maximum operation junction temperature 125°C, T_A is the ambient temperature and the θ_{JA} is the junction to ambient thermal resistance. For recommended operating conditions specification of A6303A, where $T_J(MAX)$ is the maximum junction temperature of the die (125°C) and T_A is the maximum ambient temperature. The junction to ambient thermal resistance (θ_{JA} is layout dependent) for SOT-23, SOT-25 package is 250°C/W, SC70- 5 package is 333°C/W, on standard JEDEC 51-3 thermal test board. The maximum power dissipation at T_A = 25°C can be calculated by following formula:

$$P_D(MAX) = (125^{\circ}C - 25^{\circ}C)/250 = 400 \text{mW} (SOT-23, SOT-25)$$

$$P_D(MAX) = (125^{\circ}C - 25^{\circ}C)/333 = 300 \text{mW} (SC70-5)$$

The maximum power dissipation depends on operating ambient temperature for fixed $T_J(MAX)$ and thermal resistance θ_{JA} . It is also useful to calculate the junction of temperature of the A6303A under a set of specific conditions. In this example let the Input voltage V_{IN} =3.3V, the output current Io=300mA and the case temperature T_A =40°C measured by a thermal couple during operation. The power dissipation for the V_{OUT} =2.8V version of the A6303A can be calculated as:

$$P_D = (3.3V-2.8V) \times 300mA + 3.6V \times 100uA = 150mW$$

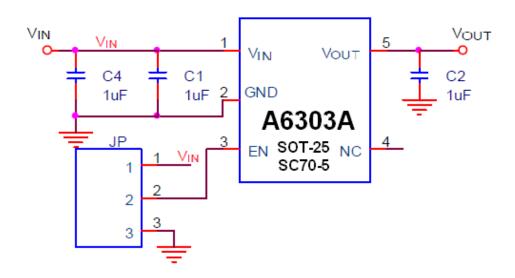
And the junction temperature, T_J, can be calculated as follows:

$$T_{J}=T_{A}+P_{D}\times\theta_{JA}=40^{\circ}C+0.15W\times250^{\circ}C/W$$

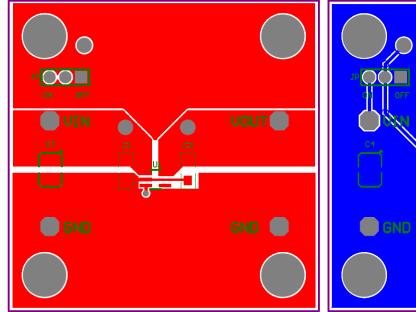
For this operating condition, T_J is lower than the absolute maximum operating junction temperature,125°C, so it is safe to use the A6303A in this configuration.

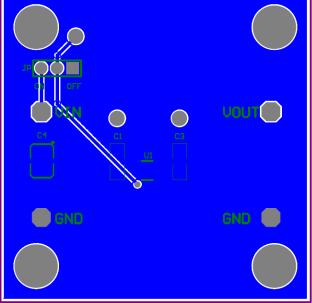
Layout considerations

To improve ac performance such as PSRR, output noise, and transient response, it is recommended that the PCB be designed with separate ground planes for V_{IN} and V_{OUT} , with each ground plane connected only at the GND pin of the device.



A6303A-2.8V(SOT-25, SC70-5) Layout Circuit



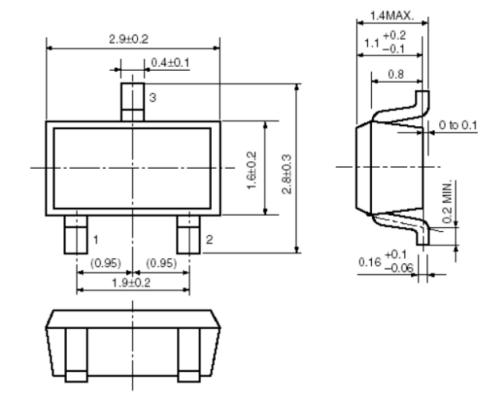


TOP Layer Layout

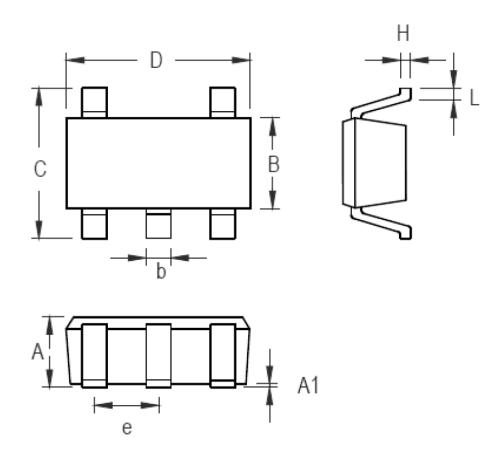
BOTTOM Layer Layout

PACKAGE INFORMATION

Dimension in SOT-23 Package (Unit: mm)

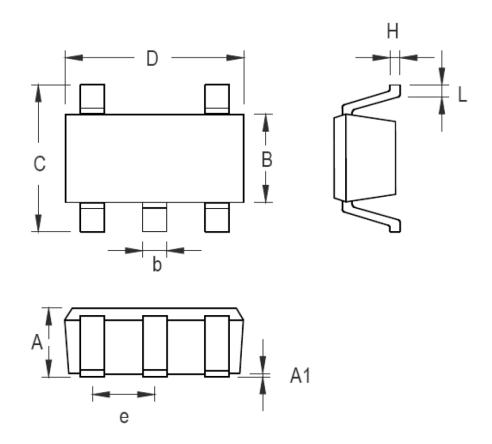


Dimension in SOT-25 (Unit: mm)



Complete	Millim	neters	Inches		
Symbol	Min	Max	Min	Max	
Α	0.889	1.295	0.035	0.051	
A1	0.000	0.152	0.000	0.006	
В	1.397	1.803	0.055	0.071	
b	0.356	0.559	0.014	0.022	
С	2.591	2.997	0.102	0.118	
D	2.692	3.099	0.106	0.122	
е	0.838	1.041	0.033	0.041	
Н	0.080	0.254	0.003	0.010	
L	0.300	0.610	0.012	0.024	

Dimension in SC70-5 (Unit: mm)



Cumah al	Millim	neters	Inches		
Symbol	Min	Max	Min	Max	
Α	0.800	1.100	0.031	0.044	
A1	0.000	0.100	0.000	0.004	
В	1.150	1.350	0.045	0.054	
b	0.150	0.400	0.006	0.016	
С	1.800	2.450	0.071	0.096	
D	1.800	2.250	0.071	0.089	
е	0.650	0.650 TYP		TYP	
Н	0.080	0.260	0.003	0.010	
L	0.210	0.460	0.008	0.018	

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